

PBSS5250X

50 V, 2 A PNP low V_{CEsat} transistor

2 February 2026

Product data sheet

1. General description

PNP low V_{CEsat} transistor in a SOT89 (SC-62) flat lead Surface-Mounted Device (SMD) plastic package.

NPN complement: PBSS4250X

2. Features and benefits

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability: I_C and I_{CM}
- Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements

3. Applications

- Power management
 - DC/DC converters
 - Supply line switching
 - Battery charger
 - LCD backlighting
- Peripheral drivers
 - Driver in low supply voltage applications (e.g. lamps and LEDs).
 - Inductive load driver (e.g. relays, buzzers and motors)

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|------------------|---------------------------|---|-----|-----|-----|------|
| V _{CEO} | collector-emitter voltage | open base | - | - | -50 | V |
| I _C | collector current | | - | - | -2 | A |
| h _{FE} | DC current gain | V _{CE} = -2 V; I _C = -0.1 A; T _{amb} = 25 °C | 200 | - | - | |

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|--------------------|----------------|
| 1 | E | emitter | <p>SOT89</p> | <p>sym132</p> |
| 2 | C | collector | | |
| 3 | B | base | | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|---------------------------|---------|--|-----------------------|
| | Name | Description | Version |
| PBSS5250X | SOT89 | plastic, surface-mounted package; 3 leads; 1.5 mm pitch; 4.5 mm x 2.5 mm x 1.5 mm body | SOT89 |

7. Marking

Table 4. Marking codes

| Type number | Marking code[1] |
|-------------|-----------------|
| PBSS5250X | %1L |

[1] % = placeholder for manufacturing site code

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|-----------|---------------------------|-----------------------------|-----|-----|------|------|
| V_{CBO} | collector-base voltage | open emitter | | - | -50 | V |
| V_{CEO} | collector-emitter voltage | open base | | - | -50 | V |
| V_{EBO} | emitter-base voltage | open collector | | - | -5 | V |
| I_C | collector current | | | - | -2 | A |
| I_{CM} | peak collector current | limited by $T_{j(max)}$ | | - | -5 | A |
| I_B | base current | | | - | -0.5 | A |
| P_{tot} | total power dissipation | $T_{amb} \leq 25\text{ °C}$ | [1] | - | 550 | mW |
| | | | [2] | - | 1 | W |
| T_j | junction temperature | | | - | 150 | °C |
| T_{amb} | ambient temperature | | | -65 | 150 | °C |
| T_{stg} | storage temperature | | | -65 | 150 | °C |

[1] Device mounted on an FR4 PCB, single-sided, 35 μ m copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided, 35 μ m copper, tin-plated, mounting pad for collector 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|----------------|--|-------------|-----|-----|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] | - | - | 225 | K/W |
| | | | [2] | - | - | 125 | K/W |
| | | | [3] | - | - | 90 | K/W |
| | | | [4] | - | - | 80 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | | - | - | 16 | K/W |

- [1] Device mounted on an FR4 PCB, single-sided, 35 μm copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided, 35 μm copper, tin-plated, mounting pad for collector 1 cm^2 .
- [3] Device mounted on an FR4 PCB, single-sided, 35 μm copper, tin-plated, mounting pad for collector 6 cm^2 .
- [4] Device mounted on a ceramic PCB, 7 cm^2 , single-sided, 35 μm copper, tin-plated; standard footprint.

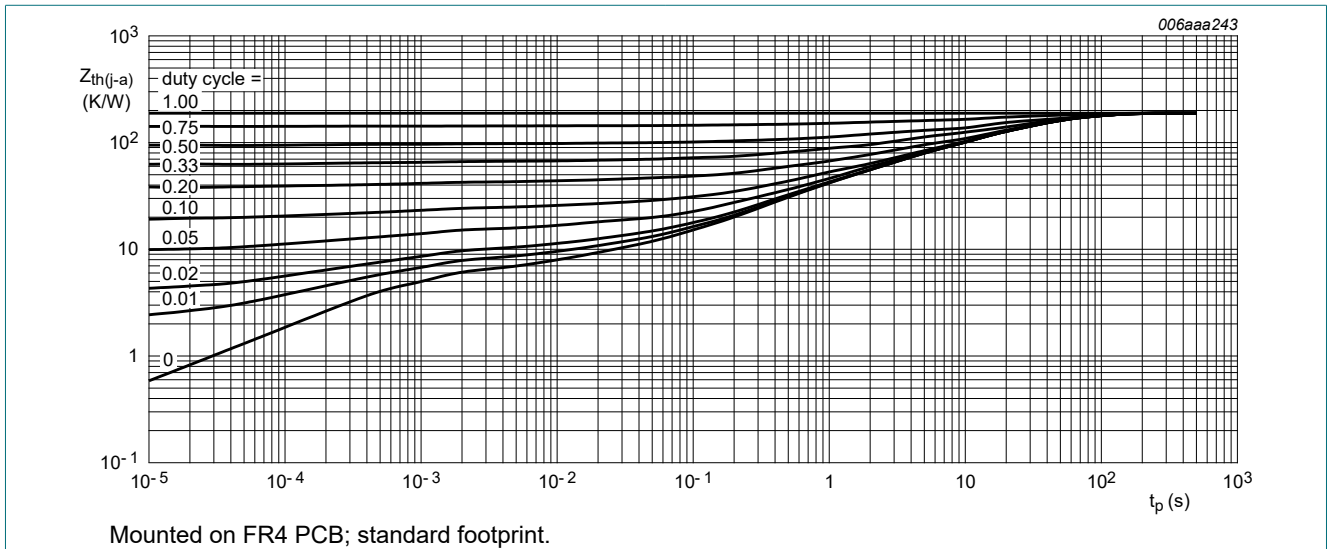


Fig. 1. Transient thermal impedance as a function of pulse duration; typical values

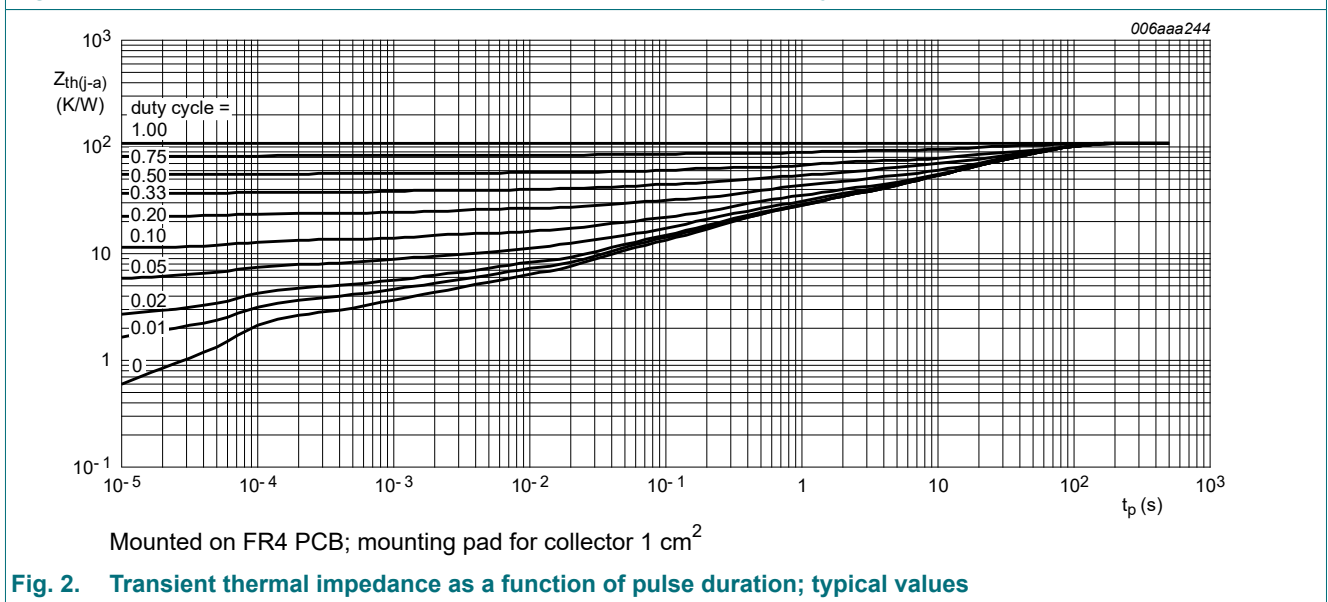
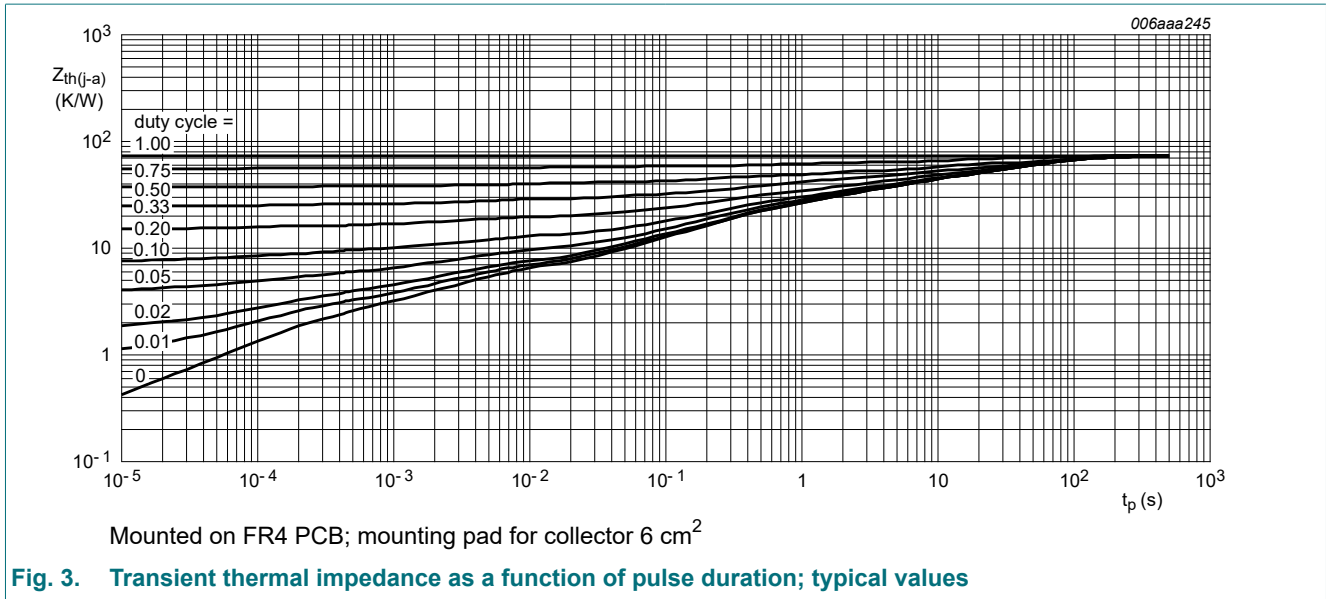


Fig. 2. Transient thermal impedance as a function of pulse duration; typical values



10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------|---|---|-----|-----|------|------------|
| $V_{(BR)CBO}$ | collector-base breakdown voltage | $I_C = -100 \mu A; I_E = 0 A; T_{amb} = 25 \text{ }^\circ C$ | -50 | - | - | V |
| $V_{(BR)CEO}$ | collector-emitter breakdown voltage | $I_C = -2 \text{ mA}; I_B = 0 A; T_{amb} = 25 \text{ }^\circ C$ | -50 | - | - | V |
| $V_{(BR)EBO}$ | emitter-base breakdown voltage | $I_E = -100 \mu A; I_C = 0 A; T_{amb} = 25 \text{ }^\circ C$ | -5 | - | - | V |
| I_{CBO} | collector-base cut-off current | $V_{CB} = -50 \text{ V}; I_E = 0 A; T_{amb} = 25 \text{ }^\circ C$ | - | - | -100 | nA |
| | | $V_{CB} = -50 \text{ V}; I_E = 0 A; T_j = 150 \text{ }^\circ C$ | - | - | -50 | μA |
| I_{CES} | collector-emitter cut-off current | $V_{CE} = -50 \text{ V}; V_{BE} = 0 \text{ V}; T_{amb} = 25 \text{ }^\circ C$ | - | - | -100 | nA |
| I_{EBO} | emitter-base cut-off current | $V_{EB} = -5 \text{ V}; I_C = 0 A; T_{amb} = 25 \text{ }^\circ C$ | - | - | -100 | nA |
| h_{FE} | DC current gain | $V_{CE} = -2 \text{ V}; I_C = -0.1 \text{ A}; T_{amb} = 25 \text{ }^\circ C$ | 200 | - | - | |
| | | $V_{CE} = -2 \text{ V}; I_C = -0.5 \text{ A}; T_{amb} = 25 \text{ }^\circ C$ | 200 | - | - | |
| | | $V_{CE} = -2 \text{ V}; I_C = -1 \text{ A}; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ C$ | 200 | - | - | |
| | | $V_{CE} = -2 \text{ V}; I_C = -2 \text{ A}; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ C$ | 100 | - | - | |
| V_{CEsat} | collector-emitter saturation voltage | $I_C = -0.5 \text{ A}; I_B = -50 \text{ mA}; T_{amb} = 25 \text{ }^\circ C$ | - | - | -90 | mV |
| | | $I_C = -1 \text{ A}; I_B = -50 \text{ mA}; T_{amb} = 25 \text{ }^\circ C$ | - | - | -250 | mV |
| | | $I_C = -2 \text{ A}; I_B = -100 \text{ mA}; T_{amb} = 25 \text{ }^\circ C$ | - | - | -380 | mV |
| | | $I_C = -2 \text{ A}; I_B = -200 \text{ mA}; \text{pulsed}; t_p \leq 300 \mu s; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ C$ | - | - | -320 | mV |
| R_{CEsat} | collector-emitter saturation resistance | | - | - | 160 | m Ω |
| V_{BEsat} | base-emitter saturation voltage | $I_C = -2 \text{ A}; I_B = -100 \text{ mA}; T_{amb} = 25 \text{ }^\circ C$ | - | - | -1.1 | V |
| V_{BEon} | base-emitter turn-on voltage | $V_{CE} = -2 \text{ V}; I_C = -1 \text{ A}; T_{amb} = 25 \text{ }^\circ C$ | - | - | -1.1 | V |

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------|-----------------------|--|-----|-----|-----|------|
| f_T | transition frequency | $V_{CE} = -5\text{ V}$; $I_C = -100\text{ mA}$; $f = 100\text{ MHz}$; $T_{amb} = 25\text{ °C}$ | 100 | - | - | MHz |
| C_c | collector capacitance | $V_{CB} = -10\text{ V}$; $I_E = 0\text{ A}$; $i_e = 0\text{ A}$; $f = 1\text{ MHz}$; $T_{amb} = 25\text{ °C}$ | - | - | 35 | pF |

11. Test information

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

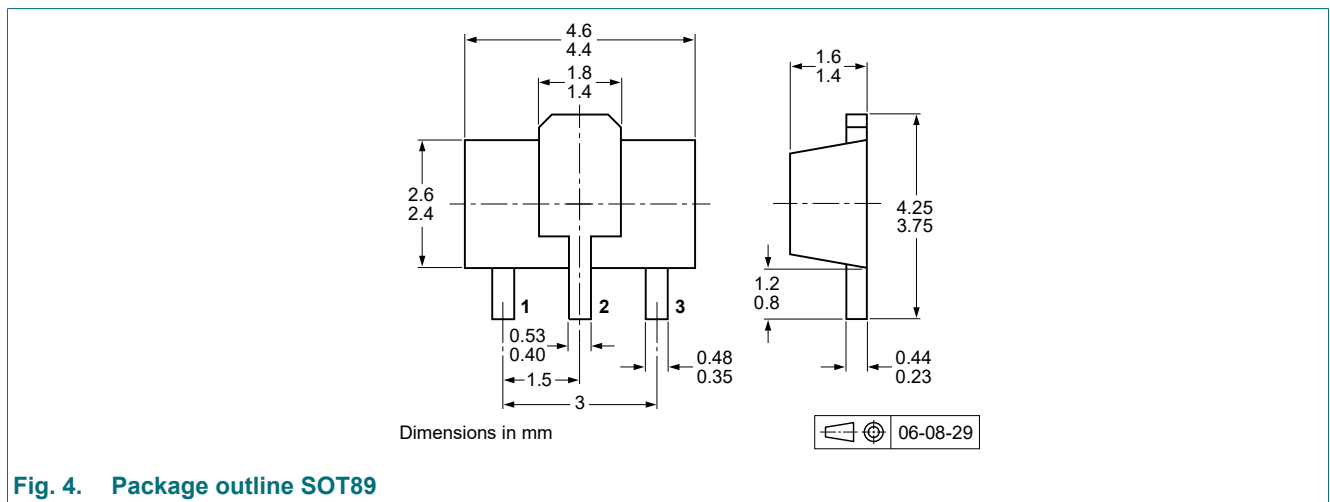


Fig. 4. Package outline SOT89

13. Soldering

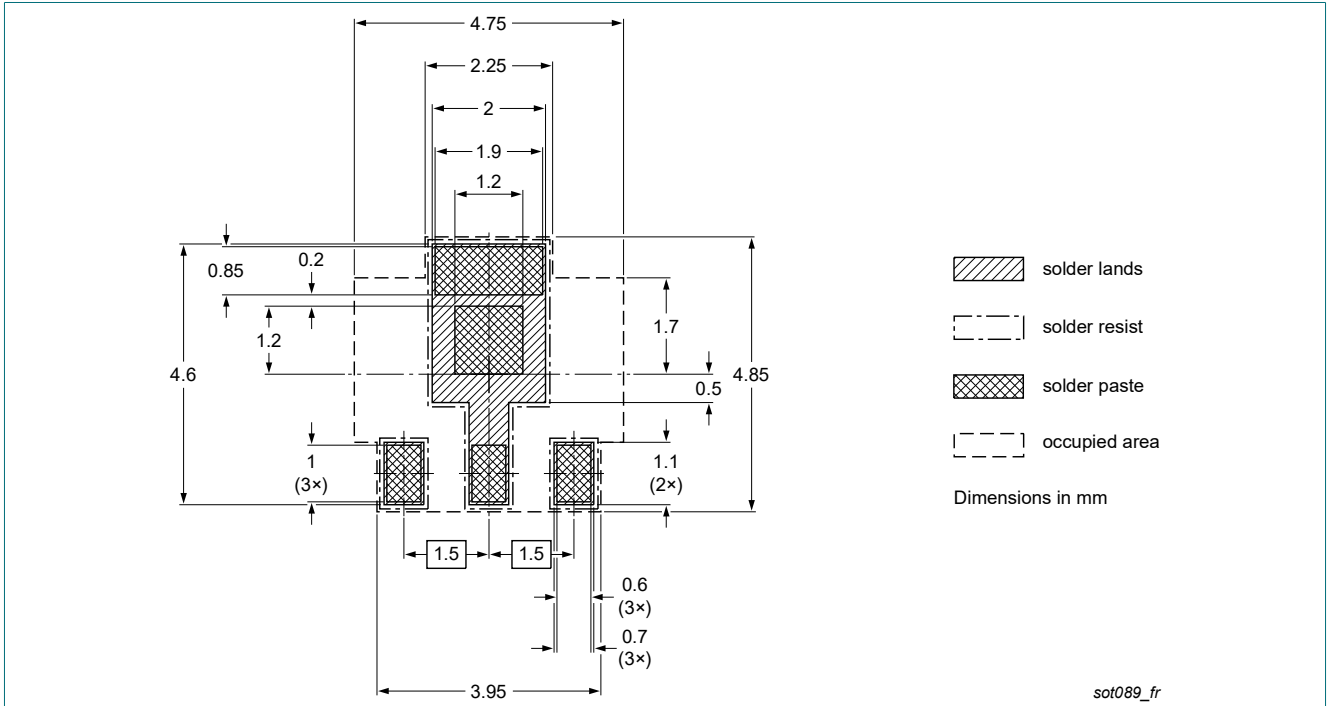


Fig. 5. Reflow soldering footprint for SOT89

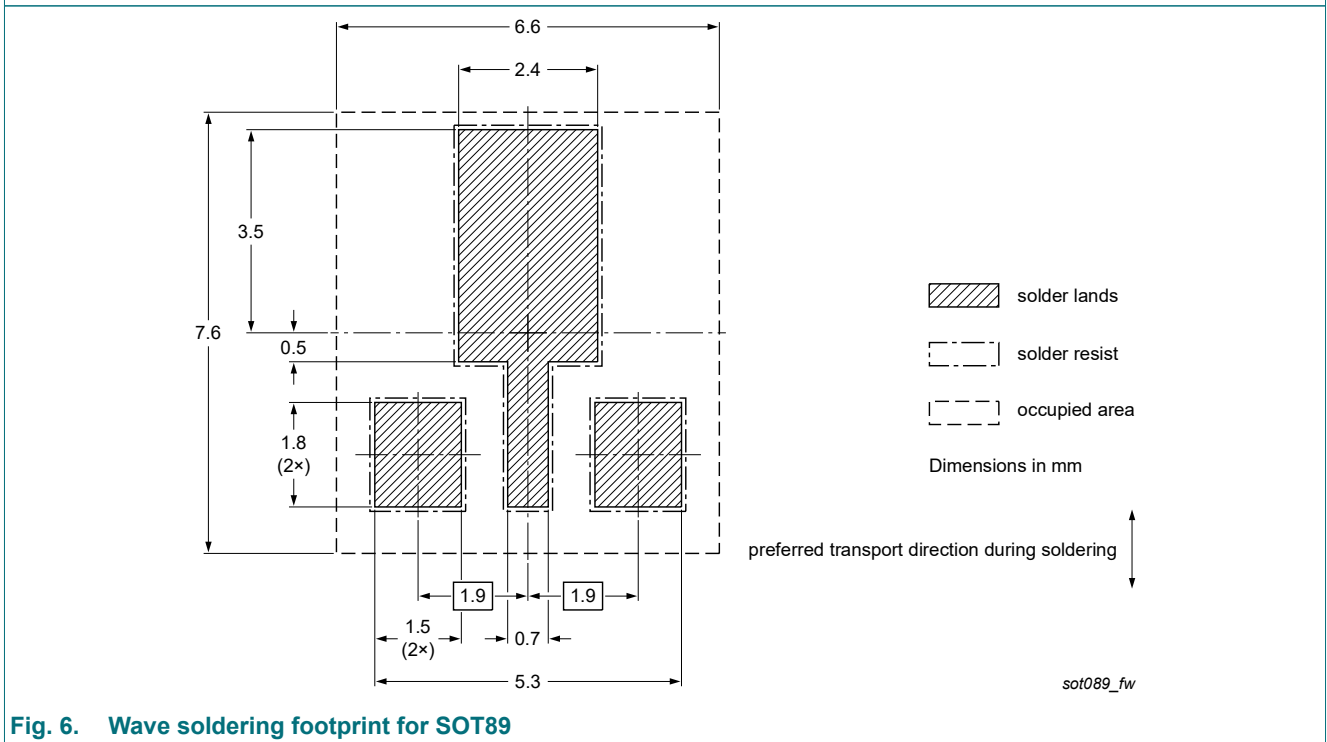


Fig. 6. Wave soldering footprint for SOT89

14. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|--|-----------------------|---------------|---------------|
| PBSS5250X v.4 | 20260202 | Product data sheet | - | PBSS5250X v.3 |
| Modifications: | • Characteristics: Typo corrected at V_{BEon} : value moved to maximum | | | |
| PBSS5250X v.3 | 20230424 | Product data sheet | - | PBSS5250X v.2 |
| PBSS5250X v.2 | 20041104 | Product data sheet | - | PBSS5250X v.1 |
| PBSS5250X v.1 | 20030617 | Product specification | - | - |

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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- [2] The term 'short data sheet' is explained in section "Definitions".
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